ASSOCIATION C ELECTRONICS I	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.		der both The	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No. Homogeneous Materi					ials and Mfg Information			
upplier I	Information													
Company name* Compan				mpany unique ID			Unique ID Authority				Response Date*			
nsemi										2025-06-08				
Contact Nan	me	Title - Contact			P	Phone - Contact*				Email - Contact*				
Product-En	v-Stewards		Product Enviro Compliance			ı	NA				Product-Env-Stewards@onsemi.com			
uthorized 1	Representative*	Title - Representative			P	Phone - Representative*			Email - Representative*					
Product-En	v-Stewards		Product Enviro Compliance			ı	NA				Product-Env-Stewards@onsemi.com			
F	Requester Item Number	Mfr Item	Number	Mfr Item Name			Effective Date	Version	N	Manufacturing Site		Veight*	UOM	Unit Type
		74ACT08SCX QUAD 2 I/P AND		QUAD 2 I/P AND	GATE		2025-06-08 PH1		1	53.57	mg	Each		
	curing Proccess Inform													
2			erminal Base Alloy J-STD-020 MSL Rating		Rating									
M	Matte Tin (Sn) - annealed		CU Alloy	1			260		C	30	secono	ds 3		
omments														
	ximum time at peak tempera													
or more inf	formation regarding materia	al composition	please refer to	page 3										

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's St											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.222	mg	Supplier	Silicon (Si)	7440-21-3		0.222	mg
Die Attach	0.09	mg		Epoxy resin	proprietary data		0.009	mg
			Supplier	Silver (Ag)	7440-22-4		0.072	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.009	mg
Lead Frame	68.01	mg	Supplier	Zinc (Zn)	7440-66-6		0.0816	mg
			Supplier	Iron (Fe)	7439-89-6		1.5982	mg
			Supplier	Copper (Cu)	7440-50-8		66.3098	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0204	mg
Lead Frame plating	0.7	mg	Supplier	Silver (Ag)	7440-22-4		0.7	mg
Mold Compound-Black	81.971	mg		Epoxy resin	proprietary data		4.0986	mg
			Supplier	Phenolic Resin	Proprietary Data		1.6394	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		2.0493	mg
			Supplier	Carbon Black (C)	1333-86-4		0.4099	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		73.7739	mg
Plating	2.514	mg	Supplier	Tin (Sn)	7440-31-5		2.514	mg
Wire Bond - Au	0.063	mg	Supplier	Gold (Au)	7440-57-5		0.063	mg